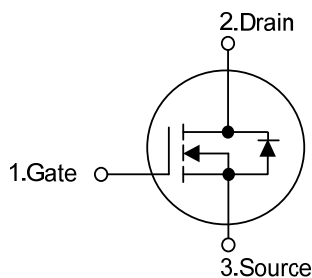


**1NM60-Q****Power MOSFET****1.0A, 600V N-CHANNEL
SUPER-JUNCTION MOSFET****DESCRIPTION**

The **UTC 1NM60-Q** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

FEATURES

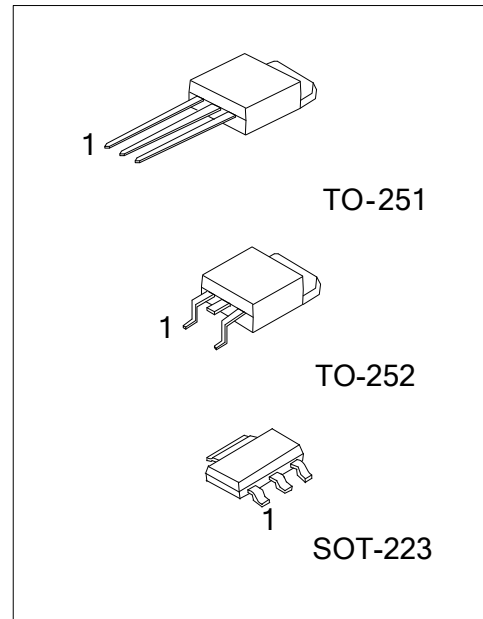
- * $R_{DS(ON)} < 4.6\Omega$ @ $V_{GS} = 10V$, $I_D = 0.5A$
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness

SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
-	1NM60G-AA3-R	SOT-223	G	D	S	Tape Reel
1NM60L-TM3-T	1NM60G-TM3-T	TO-251	G	D	S	Tube
1NM60L-TN3-R	1NM60G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

1NM60G-AA3-R (1) Packing Type (2) Package Type (3) Green Package	(1) R: Tape Reel, T: Tube (2) AA3: SOT-223, TM3: TO-251, TN3: TO-252 (3) L: Lead Free, G: Halogen Free and Lead Free
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MARKING

SOT-223	TO-251 / TO-252
1NM60G Lot Code 1 Data Code	UTC 1NM60 Lot Code 1 Data Code L: Lead Free G: Halogen Free

■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I_D	1.0	A
	Pulsed (Note 2)	I_{DM}	4.0	A
Avalanche Current (Note 2)		I_{AR}	1.3	A
Avalanche Energy		E_{AS}	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	5.5	V/ns
Power Dissipation	SOT-223	P_D	8.0	W
	TO-251/TO-252		28	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L=10\text{mH}$, $I_{AS}=1.3\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\ \Omega$, Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD}\leq 1.0\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL CHARACTERISTICS**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223	θ_{JA}	150	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	SOT-223	θ_{JC}	15.6	$^{\circ}\text{C}/\text{W}$
	TO-251/TO-252		4.46	$^{\circ}\text{C}/\text{W}$

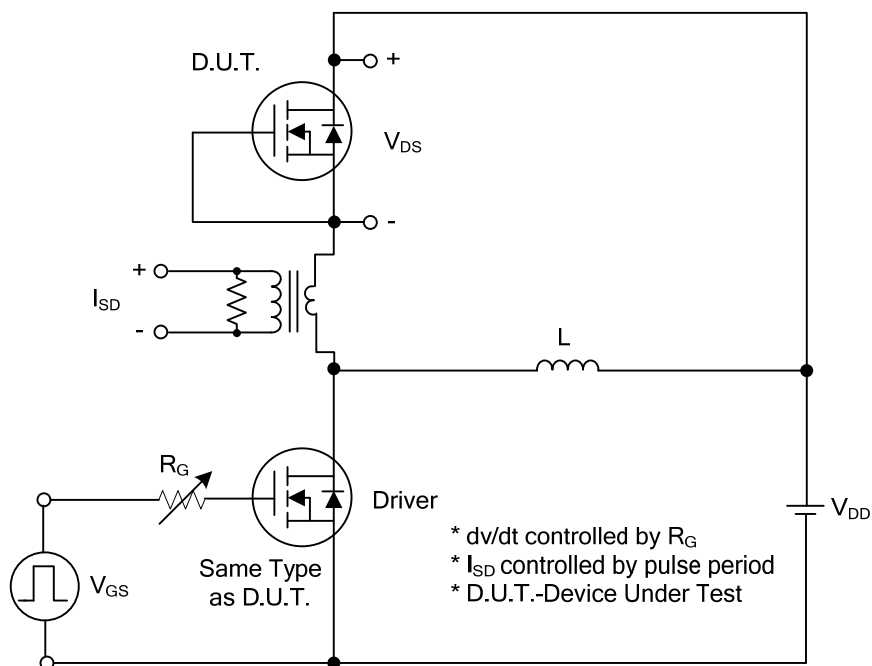
■ **ELECTRICAL CHARACTERISTICS** ($T_J = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	600			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 600V, V_{GS} = 0V$			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	$V_{GS} = +30V, V_{DS} = 0V$			+100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5		4.5	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 0.5A$			4.6	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		83		pF
Output Capacitance		C_{OSS}			62		pF
Reverse Transfer Capacitance		C_{RSS}			8.0		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_G	$V_{DS} = 50V, V_{GS} = 10V, I_D = 0.5A$ $I_G = 100\mu A$ (Note 1, 2)		19		nC
Gate to Source Charge		Q_{GS}			1.8		nC
Gate to Drain Charge		Q_{GD}			2.6		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	$V_{DD} = 30V, V_{GS} = 10V, I_D = 0.5A,$ $R_G = 25\Omega$ (Note 1, 2)		43		ns
Rise Time		t_R			36		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			59		ns
Fall-Time		t_F			25		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				1.0	A
Maximum Body-Diode Pulsed Current		I_{SM}				4.0	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	$I_S = 1.0A, V_{GS} = 0V$			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	$I_S = 1.0A, V_{GS} = 0V,$		160		nS
Body Diode Reverse Recovery Charge		Q_{rr}	$dl_F/dt = 100A/\mu s$		0.5		μC

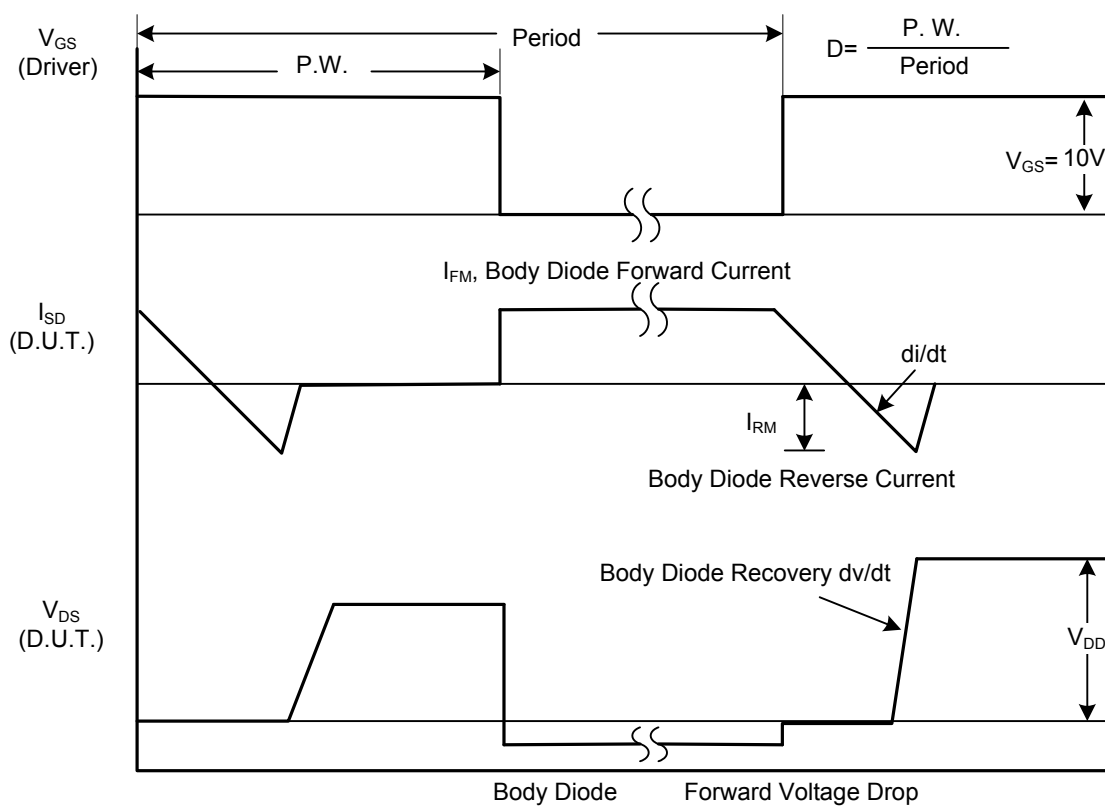
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

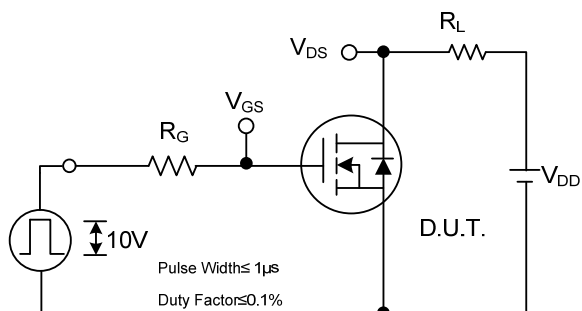


Peak Diode Recovery dv/dt Test Circuit

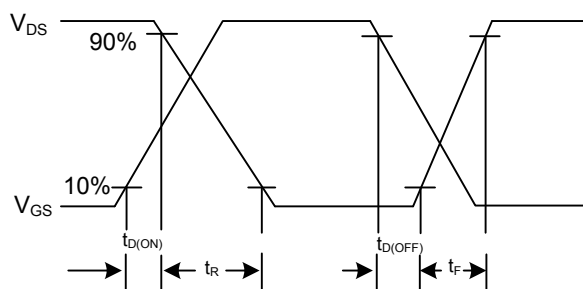


Peak Diode Recovery dv/dt Waveforms

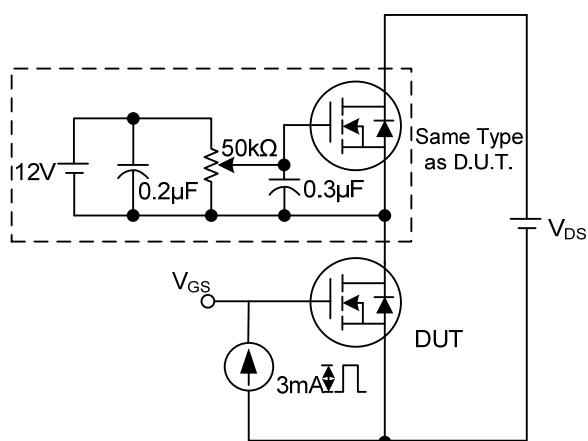
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



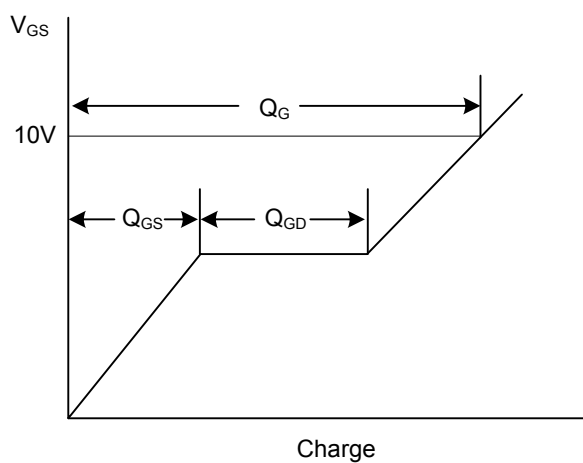
Switching Test Circuit



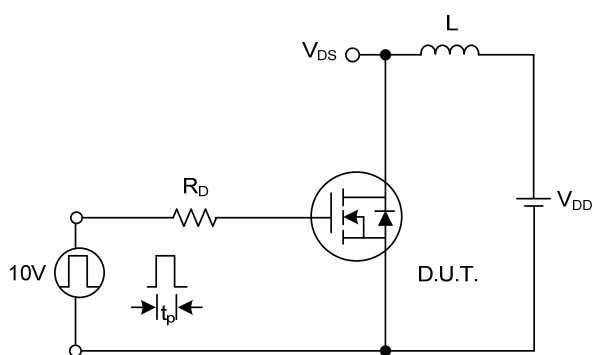
Switching Waveforms



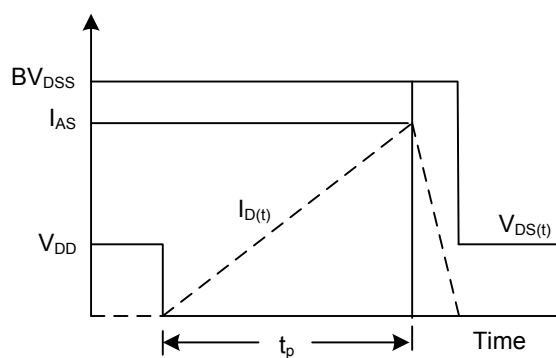
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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